

**Application Data Sheet****Application Information**

**Application Type::** Regular  
**Subject Matter::** Utility  
**CD-ROM or CD-R?::** None  
**Computer Readable Form (CRF)?::** No  
**Title::** METHOD OF FORMING THIN FILM ON  
BASE SUBSTANCE VIA INTERMEDIATE  
LAYER  
**Attorney Docket Number::** 017700-0174  
**Request for Early Publication?::** No  
**Request for Non-Publication?::** No  
**Suggested Drawing Figure::** 3  
**Total Drawing Sheets::** 3A, 3B  
**Small Entity?::** No  
**Petition included?::** No  
**Secrecy Order in Parent Appl.?::** No

**Applicant Information**

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**Primary Citizenship Country::** Japan  
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### Correspondence Information

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### Representative Information

<b>Representative Customer Number::</b>	22428	
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### Domestic Priority Information

<b>Application::</b>	<b>Continuity Type::</b>	<b>Parent Application::</b>	<b>Parent Filing Date::</b>
This Application	National Stage of	PCT/JP03/13887	10/29/2003

### Foreign Priority Information

<b>Country::</b>	<b>Application number::</b>	<b>Filing Date::</b>	<b>Priority Claimed::</b>
Japan	2002-318477	10/31/2002	Yes

### Assignee Information

**Assignee Name::**

Sumitomo Electric Industries, Ltd.

**Assignee Name::**

The International Superconductivity  
Technology Center, The Juridical Foundation